

Declaration and Power of Attorney For Patent Application

As a below named inventor, I hereby declare that:

My residence, post office address, and citizenship are as stated below next to my name. I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

LENS PRODUCING METHOD, INJECTION MOLDING DIE FOR MOLDING A LENS AND LENS

MOLDING

the specification of which (check one)

☐ is attached hereto.

☒ was filed on January 17, 1997 as Application Serial No. PCT/JP97/00078
and was amended on _____ (if applicable)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above, to the best of my ability. I acknowledge the duty to disclose information which is material to the examination of this application in accordance with 37 C.F.R. 1.56(a) and 35 U.S.C. 102 and 103. I hereby claim foreign priority benefits under 35 U.S.C. 119/365 of any foreign application(s) for patent or inventor's certificate filed by me or my assignee disclosing the subject matter claimed in this application and having a filing date (1) before that of the application on which priority is claimed, or (2) if no priority claimed, before the filing date of this application:


Number	Prior foreign application(s)			Priority claimed	
	Country	Day/Month/Year Filed	Yes	No	
[8-6407]	[Japan]	[18/01/1996]	[X]	[]	
[8-34749]	[Japan]	[22/02/1996]	[X]	[]	
[]	[]	[]	[]	[]	
[]	[]	[]	[]	[]	
[]	[]	[]	[]	[]	
[]	[]	[]	[]	[]	
[]	[]	[]	[]	[]	

I hereby claim the benefit under 35 U.S.C. 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of 37 C.F.R. 1.56 (a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Application Serial No.	Filing Date	Status(patented, pending, abandoned)
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I hereby declare that all statement made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

And I hereby appoint Flynn, Thiel, Boutell & Tanis, P.C., 2026 Rambling Road, Kalamazoo, Michigan 49008-1699, telephone number 616-381-1156 (to whom all communications are to be directed), and the below named partners thereof (of the same address) individually and collectively my attorneys to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith and with the resulting patent, and I hereby authorize them to act and rely on instructions from and communicate directly with the person/assignee/attorney/ firm/organization who/which first sends/sent this case to them and by whom/which I hereby declare that I have consented after full disclosure to be represented unless/until I instruct Flynn, Thiel, Boutell & Tanis, P.C. in writing to the contrary.

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David G. Boutell 25072
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Full name of third inventor: _____

Third Inventor's signature: _____

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Full name of fourth inventor: _____

Fourth Inventor's signature: _____

Date: _____

Residence: _____

Citizenship: _____

Post Office Address: _____

Full name of fifth inventor: _____

Fifth Inventor's signature: _____

Date: _____

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